

MAY 24-27, 2026
International Convention Center
SHANGHAI CHINA

**Call For Cross-Society
Special Sessions**

Aug. 26 2026

Proposal Submission

Sep. 2 2026

Proposal Notification

Oct. 12 2026

Paper Submission

CALL FOR CROSS-SOCIETY SPECIAL PAPERS

The Organizing Committee of ISCAS 2026 invites proposals for Cross-Society Special Sessions to be held during the conference in Shanghai, China, 24–27 May 2026.

These sessions are designed to complement the regular technical program by showcasing emerging research areas, transformative ideas, and innovative applications that span across traditional disciplinary boundaries.

Proposals should focus on timely, high-impact topics that are likely to stimulate cross-disciplinary collaboration and attract broad interest. All papers submitted to Cross-Society Special Sessions will undergo the same rigorous peer-review process as regular submissions to ensure the highest quality standards.

Proposal Guidelines:

- Each Cross-Society Special Session must be jointly organized by members from at least two different IEEE societies (with supporting letter from the conference organizer).
- Organizers are expected to have successfully organized a similar special session at the respective flagship conferences of at least two IEEE societies. This helps in building momentum and visibility for the topic, and in attracting high-quality submissions from a broad spectrum of researchers.

Proposal should include the following information (3 pages max.)

- Title and abstract:** A title and a concise abstract
- Rationale:** Explain why the topic is emerging and timely, describe its relevance to the ISCAS community and alignment with the innovation themes (if applicable).
- Proposed speakers:** Provide a list of all talks, speakers, and co-authors (in each associated paper). Technical sessions are normally expected to have 5 papers.
- Short biographies:** Provide a short bio-sketch of the session proposers.
- Email Support:** An supporting email will be required at the submission of proposal from other societies. Please contact Yongfu Li to obtain email support from ISCAS'26 if you need it to get support from us while communicating with other conference organizers.

Special Session Co-Chairs

Yongfu Li

Shanghai Jiao Tong University

Xiaojun Guo

Shanghai Jiao Tong University

Shouyi Yin

Tsinghua University

Qing Luo

Inst. of Microelectronics, CAS



2026.ieee-iscas.org

Proposals will be evaluated based on the relevance and timeliness of the topic, technical quality and track record of organizers and speakers, coherence and added value to the ISCAS 2026 program. The Involvement of industry speakers is encouraged and will be viewed positively.

Honorary Chair:

Junfa Mao
Shenzhen University

General Co-Chairs:

Yong Lian
York University

Ming Liu
Fudan University

Shao-Jun Wei
Tsinghua University

Gianluca Setti
King Abdullah University
of Science and Tech.

TPC Co-Chairs:

Wei-Sheng Zhao
Beihang University

Xinmiao Zhang
Ohio State University

Eduard Alarcon
UPC Barcelona Tech

Yoshifumi Nishio
Tokushima University